

DELPHI TECHNOLOGIES, INC.

Customer Number 22851

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Troy, Michig

12-05-2005



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Enclosed for recording is Assignment documentation for the following patent application:

Attorney Docket No.: DP-314010

- (1) Assignor/Inventors: M. Ray Fairchild; Aleksandra Djordjevic; and Javier Ruiz
- (2) Assignee: DELPHI TECHNOLOGIES, INC.
Legal Staff - Mail Code: 480-410-202
P.O. Box 5052
TROY, MICHIGAN 48007-5052
- (3) Assignment of patent application

(4) Application number:
If blank, this documentation is filed together with the patent application.

(5) Address correspondence to: Stefan V. Chmielewski
DELPHI TECHNOLOGIES, INC.
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Troy, Michigan 48007-5052

(6) Number of applications: 1
Total Fee: 40.00

Date documentation executed: 11-15-05; 11-15-05; and 11-15-05.

(8) Not applicable

(9) To the best of my knowledge and belief, the information contained on this cover sheet is true and correct and any copy submitted is a true copy of the original document.

Title: THERMAL CONDUCTIVE ELECTRONICS SUBSTRATE AND ASSEMBLY

Please charge the \$ 40.00 assignment recordal fee to Delphi Technologies, Inc. Deposit Account No. 50-0831.

Stefan V. Chmielewski
Stefan V. Chmielewski

Total number of pages including cover sheet, attachments and document: 2

Enclosures


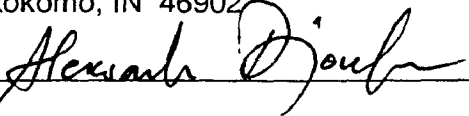
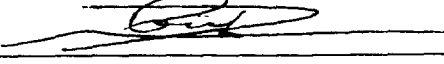
12/02/2005 DBYRNE 00000265 500831 11287834
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ASSIGNMENT

Pursuant to an agreement with my employer, I formally assign to DELPHI TECHNOLOGIES INC., the entire right, title and interest, in all countries, in the improvements set forth in the United States patent application DP-314010 entitled

THERMAL CONDUCTIVE ELECTRONICS SUBSTRATE AND ASSEMBLY

for which I executed a declaration dated as indicated below. If the patent application has been filed, I authorize the Vice President of Delphi Technologies, Inc., or his designate, to insert the application number and filing date of said application here in parentheses (_____ filed _____) when known.

Inventor's signature	<u></u>	Date	<u>11-15-05</u>
Full name:	M. Ray Fairchild	Declaration dated:	
Residence:	Kokomo, IN 46902		<u>11-15-05</u>
Inventor's signature	<u></u>	Date	<u>11-15-05</u>
Full name:	Aleksandra Djordjevic	Declaration dated:	
Residence:	Kokomo, IN 46902		<u>11-15-05</u>
Inventor's signature	<u></u>	Date	<u>11/15/05</u>
Full name:	Javier Ruiz	Declaration dated:	
Residence:	Noblesville, IN 46060		<u>11/15/05</u>